TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (L^2 - π -MOSV)

2SK2962

Chopper Regulator, DC-DC Converter and Motor Drive Applications

• 4-V gate drive

• Low drain-source ON resistance : $R_{DS (ON)} = 0.5 \Omega (typ.)$

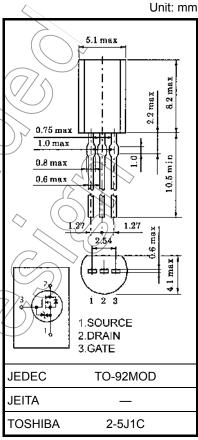
• High forward transfer admittance : |Y_{fs}| = 1.2 S (typ.)

• Low leakage current : I_{DSS} = 100 μA (max) (V_{DS} = 100 V)

• Enhancement mode : $V_{th} = 0.8$ to 2.0 V ($V_{DS} = 10$ V, $I_D = 1$ mA)

Absolute Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit
Drain-source voltage		V _{DSS}	100	V
Drain-gate voltage (Ro	_{SS} = 20 kΩ)	V_{DGR}	100	V
Gate-source voltage		V _{GSS}	±20	\lor v
Drain current	DC (Note 1)	I _D		Α
	Pulse (Note 1)	I _{DP}	3	A
Drain power dissipation	1	PD	0.9	/ (w
Single pulse avalanche	energy (Note 2)	Eas	137	mJ
Avalanche current		IAR \	1 (Α
Repetitive avalanche e	nergy (Note 3)	(EAR))	0.09	mJ
Channel temperature		Tch	150	°C
Storage temperature ra	inge	T _{stg}	-55 to 150	°C



Weight: 0.36 (typ.)

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Thermal Characteristics

Characteristics Symbol	Max	Unit
Thermal resistance, channel to ambient Rth (ch-a)	138	°C/W

Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2: V_{DD} = 25 V, T_{ch} = 25°C (initial), L = 221 mH, R_G = 25 Ω , I_{AR} = 1 A

Note 3: Repetitive rating: pulse width limited by maximum channel temperature

This transistor is an electrostatic-sensitive device.

Please handle with caution.

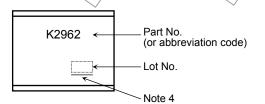
Electrical Characteristics (Ta = 25°C)

Chara	cteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage co	urrent	I _{GSS}	V _{GS} = ±16 V, V _{DS} = 0 V	_	_	±10	μΑ
Drain cut-off cu	ırrent	I _{DSS}	V _{DS} = 100 V, V _{GS} = 0 V	_	_	100	μΑ
Drain-source b	reakdown voltage	V (BR) DSS	I _D = 10 mA, V _{GS} = 0 V	100	_	_	V
Gate threshold	voltage	V _{th}	V _{DS} = 10 V, I _D = 1 mA	0.8	_	2.0	V
Drain-source ON resistance		R _{DS} (ON)	V _{GS} = 4 V, I _D = 0.5 A		0.65	0.95	Ω
Diair Source C	TV Tesistanee	NDS (ON)	V _{GS} = 10 V, I _D = 0.5 A) />	0.5	0.7	22
Forward transfe	r admittance	Y _{fs}	V _{DS} = 10 V, I _D = 0.5 A	0.6	1.2	_	S
Input capacitan	ce	C _{iss}			140	_	
Reverse transfer capacitance		C _{rss}	V _{DS} = 10 V, V _{GS} = 0 V, f = 1 MHz	_	20	_	pF
Output capacitance		Coss			45	_	
Switching time	Rise time	t _r	V _{GS} OV I I V OV OUT	- (8	>	
	Turn-on time	t _{on}	R _L = 100 Ω		13) _	20
	Fall time	t _f	V _{DD} ≒50V		45	_	ns
	Turn-off time	t _{off}	Duty ≤1%, t _w =10μs) –	175	_	
Total gate charq plus gate-drain	ge (gate-source)	Qg			6.3		
Gate-source charge		Qgs	$V_{DD} \approx 80 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 1 \text{ A}$	_	4.3	_	nC
Gate-drain ("mi	ller") Charge	Qgø			2	_	

Source-Drain Ratings and Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)	I _{DR}	_	_	_	1	Α
Pulse drain reverse current (Note 1)	I _{DRP}	_	_	_	3	Α
Forward voltage (diode)	V _{DSF}	I _{DR} = 1 A, V _{GS} = 0 V	_	_	-1.5	V
Reverse recovery time	t _{rr}	I _{DR} = 1 A, V _{GS} = 0 V, dI _{DR} / dt = 50 A / µs	_	80	_	ns
Reverse recovery charge	Qrr	1DR - 1 A, VGS - 0 V, αιDR / αι - 30 A / μs	_	140	_	nC

Marking

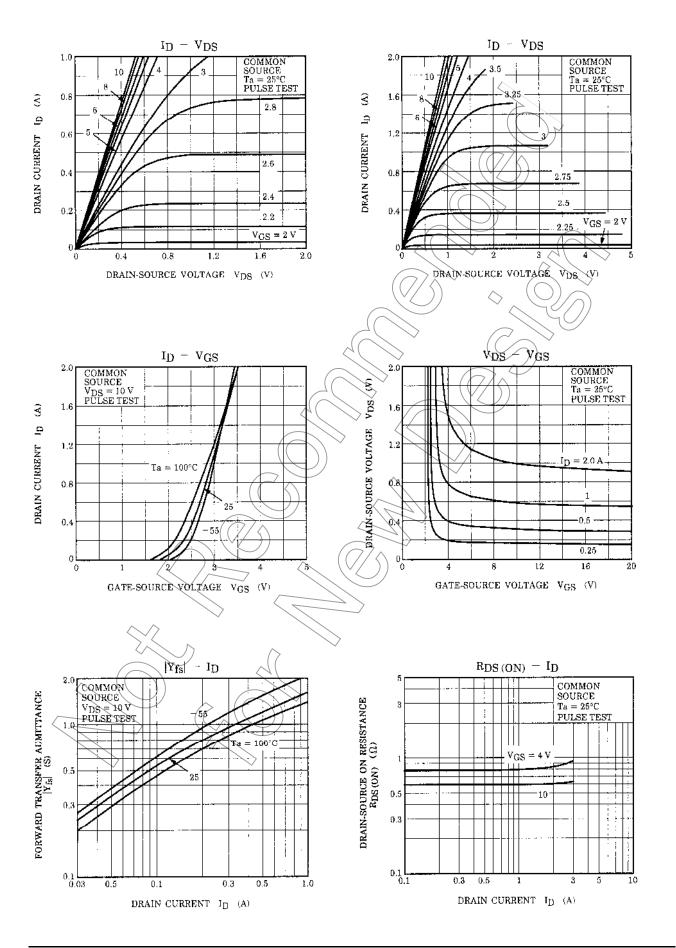


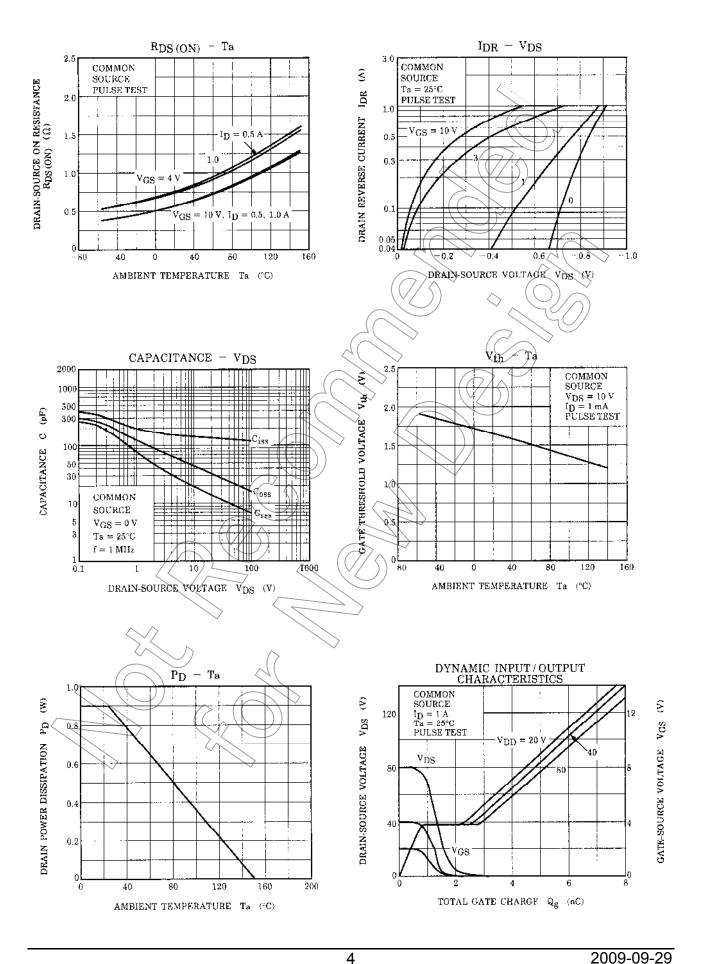
Note 4: A line under a Lot No. identifies the indication of product Labels.

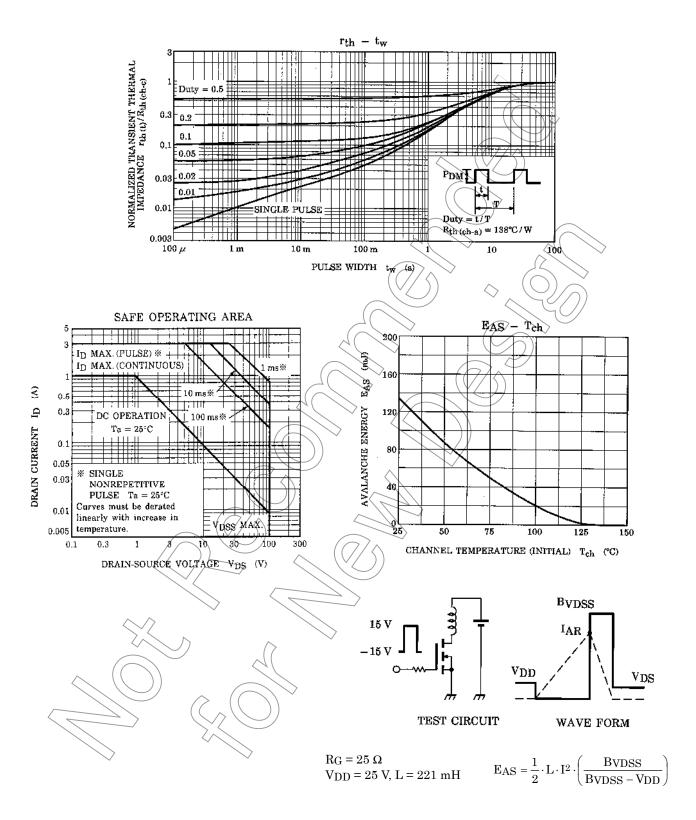
Not underlined: [[Pb]]/INCLUDES > MCV Underlined: [[G]]/RoHS COMPATIBLE or [[G]]/RoHS [[Pb]]

Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of Product. The RoHS is the Directive 2002/95/EC of the European Parliament and of the Council of 27 January 2003 on the restriction of the use of certain hazardous substances in electrical and electronic equipment.

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